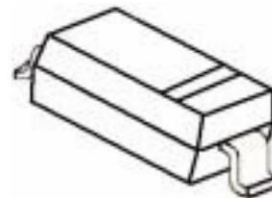


Features

- High Current Capability
- Low Forward Voltage Drop



Mechanical Data

- SOD-123 Small Outline Plastic Package
- Polarity: Color band denotes cathode end
- Mounting Position: Any

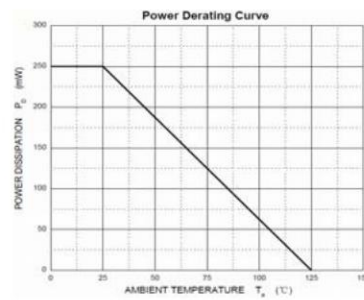
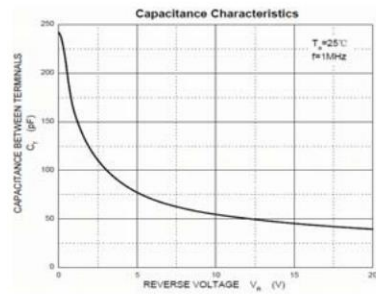
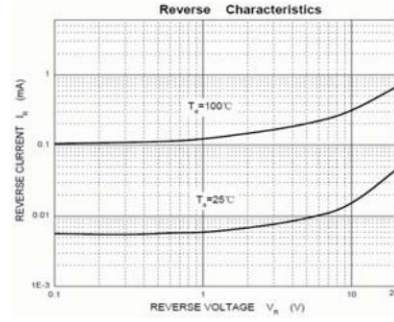
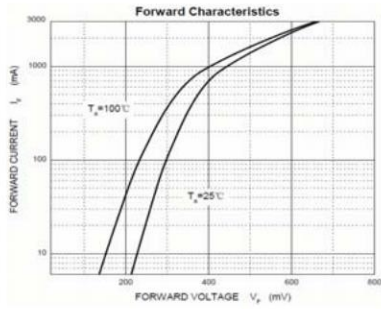
Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

Parameters	Symbol	1N5817HW	1N5818HW	1N5819HW	Unit
Maximum repetitive peak reverse voltage	VRRM	20	30	40	V
Maximum RMS voltage	VRMS	14	21	28	V
Maximum DC blocking voltage	VDC	20	30	40	V
Maximum average forward rectified current	IFM	1.0			A
Peak forward surge current 8.3 ms single half sine-wave	IFSM	9			A
Typical Current Squared Time	I ² T	0.336			A ² S
Typical thermal resistance	RθJA	250			°C/W
Power Dissipation	PD	500			mW
Storage temperature range	TSTG / T _J	-50-+150			°C

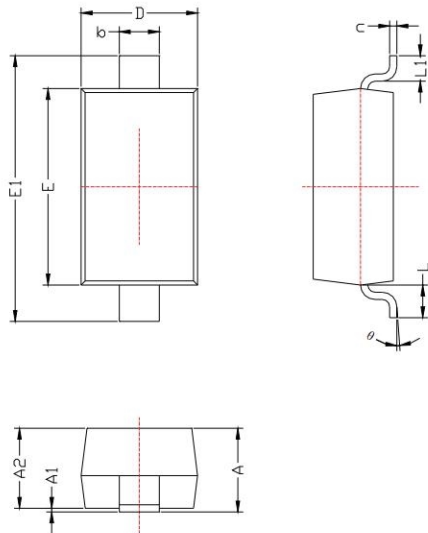
Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

Parameters	Symbol	Test conditions	1N5817HW	1N5818HW	1N5819HW	Unit
Maximum forward voltage	V _F	IF = 0.5A IF = 1.0A IF = 3.0A	- 0.450 0.750	0.450 0.550 0.875	0.450 0.600 0.900	V
Maximum reverse breakdown voltage	V _R	IR=1mA	20	30	40	V
Maximum reverse current	I _R	VR=20V 1N5817HW VR=30V 1N5818HW VR=40V 1N5819HW	1.0			mA
Type junction capacitance	C _j	VR = 4.0V, f = 1MHz	120			pF

RATING AND CHARACTERISTICS CURVES

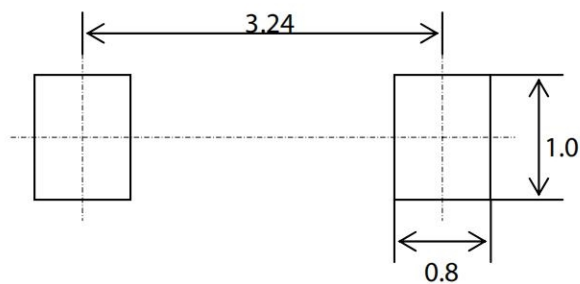


SOD-123 PA CKAGE OUTLINE Plastic surface mounted package



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
θ	0°	8°

Precautions: PCB Design(Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs)



中心距: 3.24
脚宽: 0.55
焊盘宽: 1.00
脚长: 0.50
焊盘长: 0.80

技术要求:

- 1, 塑封体尺寸: 2.70 X 1.60
- 2: 未注公差为: ± 0.05
- 3, 所有单位: mm